

### General Description

The 1405 is a N-channel Power MOSFET. It has specifically been designed to minimize input capacitance and gate charge. The device is therefore suitable in advanced high-efficiency switching applications.

### Features

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	55	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10\text{V}$	140	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10\text{V}$	99	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	420	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	550	mJ
$P_D@T_C=25^\circ\text{C}$	Power Dissipation	200	W
$T_{STG}$	Storage Temperature Range	-55 to 175	°C
$T_J$	Operating Junction Temperature Range	-55 to 175	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Junction-to-Ambient (PCB mount) <sup>3</sup>	---	40	°C/W
$R_{\theta JC}$	Junction-to-Case	---	0.75	°C/W

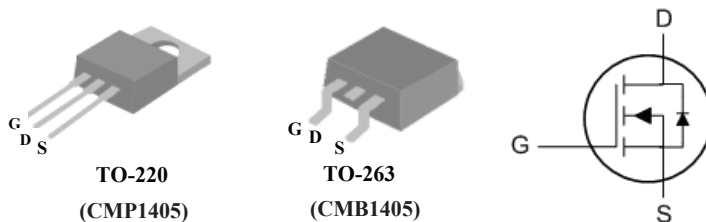
### Product Summary

BVDSS	RDSON	ID
55V	5.5mΩ	140A

### Applications

- LED power controller
- DC-DC & DC-AC converters
- High current, High speed switching
- Solenoid and relay drivers
- Motor control, Audio amplifiers

### TO220 / TO263 Pin Configuration



TO-220  
(CMP1405)

TO-263  
(CMB1405)

## N-Channel Enhancement Mode Field Effect Transistor

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$ , $I_D=250\mu A$	55	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	BVDSS Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=1mA$	---	0.057	---	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$ , $I_D=101A$ 4	---	---	5.5	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=10V$ , $I_D=250\mu A$	2	---	4	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=55V$ , $V_{GS}=0V$	---	---	20	$\mu A$
		$V_{DS}=44V$ , $V_{GS}=0V@150^\circ\text{C}$	---	---	250	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V$	---	---	$\pm 200$	nA
$Q_g$	Total Gate Charge	$I_D=101A$	---	160	---	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=44V$	---	40	---	
$Q_{gd}$	Gate-Drain Charge	$V_{GS}=10V$ 4	---	58	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=38V$ $I_D=110A$ $R_G=1.1\Omega$ , $V_{GS}=10V$ 4	---	18	---	ns
$T_r$	Rise Time		---	175	---	
$T_{d(off)}$	Turn-Off Delay Time		---	138	---	
$T_f$	Fall Time		---	100	---	
$C_{iss}$	Input Capacitance	$V_{DS}=25V$ , $V_{GS}=0V$ , $f=1MHz$	---	4800	---	pF
$C_{oss}$	Output Capacitance		---	1080	---	
$C_{rss}$	Reverse Transfer Capacitance		---	250	---	

## Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	140	A
$I_{SM}$	Pulsed Source Current <sup>1</sup>		---	---	420	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V$ , $I_S=101A$ , $T_J=25^\circ\text{C}$ 4	---	---	1.3	V

Note :

- 1.Repetitive rating; pulse width limited by max. junction temperature.
- 2.Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.11mH$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 101A$ .
- 3.This is applied to D2Pak, when mounted on 1" square PCB (FR-4 or G-10 Material).
- 4.Pulse width  $\leq 400\mu s$ ; duty cycle  $\leq 2\%$ .